Special Issue

Smart Wearable Technology: Thermal Management and Energy Applications

Message from the Guest Editors

This Special Issue, entitled "Smart Wearable Technology: Thermal Management and Energy Applications", will focus on the relevant smart wearable technologies, including, but not limited to, human body thermal and moisture management, radiative cooling, phase change materials, thermal comfort, sweat evaporation, evaporation induced electricity generation, thermoelectric effects, piezoelectricity, triboelectricity, etc. Research papers, communications, and reviews are all welcome.

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Deadline for manuscript submissions

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